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**APPLICATION DATA SHEET**

Electronic Version v14

Stylesheet Version v14.0

<b>Title of Invention</b>	<b>TORCH BUMP</b>
<b>Application Type:</b> regular, utility <b>Attorney Docket Number:</b> 27-067.D1	
<b>Correspondence address:</b> <b>Customer Number:</b> 22898 *22898*	
<b>Continuing Data:</b>  This is a Division of US application number 10/151,977, filed 2002-05-21 , now U.S. Patent Number 6,740,577.	
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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